Data Sheet

1N3600 1N4150

SILICON SWITCHING DIODE

JEDEC DO-35 CASE



Manufacturers of World Class Discrete Semiconductors

## DESCRIPTION

The CENTRAL SEMICONDUCTOR 1N3600, 1N4150, silicon planar epitaxial diode is characterized by its miniature size, ultra fast switching speed, low capacitance, low leakage, and high conductance. Accordingly, it is ideally suited for applications such as pulse applications, avalanche circuits, core drivers, and for any critical circuit requiring high conductance at power dissipation without sacrificing fast recovery capability. (Both devices have identical electrical and mechanical specifications). MAXIMUM RATINGS ( $T_{\Delta}=25^{\circ}C$ )

	SYMBOL		UNIT
Peak Working Inverse Voltage	VRWM	50	 V
Average Forward Current	I <sub>0</sub>	200	mA
Forward Steady State Current	l <sub>F</sub>	400	mA
Recurrent Peak Forward Current	İf	600	mA
Peak Forward Surge Current (1.0s Pulse)	FSM	1.0	А
Peak Forward Surge Current (1.0µs Pulse)	FSM	4.0	А
Power Dissipation	PD	500	mW
Operating and Storage			
Junction Temperature	TJ, TSTG	-65 to +200	°C

ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	МАХ	UNIT
I R	V <sub>R</sub> =Rated V <sub>RWM</sub>		100	nA
I <sub>R</sub>	V <sub>R</sub> =Rated V <sub>RWM</sub> , T <sub>A</sub> =150°C		100	μA
BVR	Ι <sub>R</sub> =5.0μΑ	75		V
VF	I <sub>F</sub> =1.0mA	0.54	0.62	V
VF	I <sub>F</sub> =10mA	0.66	0.74	V
VF	F=50mA	0.76	0.86	V
V <sub>F</sub>	$I_{F}=100 \text{mA}$	0.82	0.92	V
VF	F=200mA	0.87	1.0	V
L	$V_R=0V$ , f=1.0MHz		2.5	рF
tfr	$V_{fr}=1.0V$ , $I_{f}=200mA$ , $t_{r}=0.4ns$		10	ns
trr	$f = 1r = 10 \text{ mA}$ to 200 mA, $R_L = 100 \Omega$		4.0	ns
trr	$I_f = I_r = 200 \text{ mA}$ to $400 \text{ mA}$ , $R_L = 100 \Omega$		6.0	ns

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### CONTACT US

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